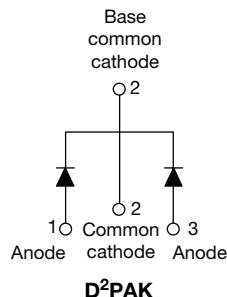
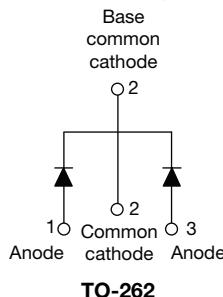


## Schottky Rectifier, 2 x 20 A

**VS-40L15CTSPbF**

**VS-40L15CT-1PbF**


### FEATURES

- 125 °C  $T_J$  operation ( $V_R < 5$  V)
- Center tap module
- Optimized for OR-ing applications
- Ultralow forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified



**RoHS**  
COMPLIANT  
HALOGEN  
FREE

### DESCRIPTION

The center tap Schottky rectifier module has been optimized for ultralow forward voltage drop specifically for the OR-ing of parallel power supplies. The proprietary barrier technology allows for reliable operation up to 125 °C junction temperature. Typical applications are in parallel switching power supplies, converters, reverse battery protection, and redundant power subsystems.

### PRODUCT SUMMARY

$I_{F(AV)}$	2 x 20 A
$V_R$	15 V
$I_{RM}$	600 mA at 100 °C

### MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform	40	A
$V_{RRM}$		15	V
$I_{FSM}$	$t_p = 5 \mu s$ sine	700	A
$V_F$	19 Apk, $T_J = 125$ °C (per leg, typical)	0.25	V
$T_J$		- 55 to 125	°C

### VOLTAGE RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VS-40L15CTSPbF VS-40L15CT-1PbF	UNITS
Maximum DC reverse voltage	$V_R$			
Maximum working peak reverse voltage	$V_{RWM}$	$T_J = 100$ °C	15	V

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current per leg See fig. 5	$I_{F(AV)}$	50 % duty cycle at $T_C = 85$ °C, rectangular waveform	20	A
per device			40	
Maximum peak one cycle non-repetitive surge current per leg See fig. 7	$I_{FSM}$	5 $\mu s$ sine or 3 $\mu s$ rect. pulse	700	
		10 ms sine or 6 ms rect. pulse	330	
Non-repetitive avalanche energy per leg	$E_{AS}$	$T_J = 25$ °C, $I_{AS} = 2$ A, $L = 6$ mH	10	mJ
Repetitive avalanche current per leg	$I_{AR}$	Current decaying linearly to zero in 1 $\mu s$ Frequency limited by $T_J$ maximum $V_A = 1.5 \times V_R$ typical	2	A

**ELECTRICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS	
Maximum forward voltage drop per leg See fig. 1	$V_{FM}^{(1)}$	19 A	$T_J = 25 \text{ } ^\circ\text{C}$	-	0.41	V	
		40 A		-	0.52		
		19 A	$T_J = 125 \text{ } ^\circ\text{C}$	0.25	0.33		
		40 A		0.37	0.50		
Reverse leakage current per leg See fig. 2	$I_{RM}^{(1)}$	$T_J = 25 \text{ } ^\circ\text{C}$	$V_R = \text{Rated } V_R$	-	10	mA	
		$T_J = 100 \text{ } ^\circ\text{C}$		-	600		
Threshold voltage	$V_{F(TO)}$	$T_J = T_J \text{ maximum}$		0.182		V	
Forward slope resistance	$r_t$			7.6		$\text{m}\Omega$	
Maximum junction capacitance per leg	$C_T$	$V_R = 5 \text{ V}_\text{DC}$ (test signal range 100 kHz to 1 MHz), $25 \text{ } ^\circ\text{C}$		-	2000	pF	
Typical series inductance per leg	$L_S$	Measured lead to lead 5 mm from package body		8	-	nH	
Maximum voltage rate of change	$dV/dt$	Rated $V_R$		10 000		V/ $\mu$ s	

**Note**(1) Pulse width < 300  $\mu$ s, duty cycle < 2 %**THERMAL - MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum junction temperature range	$T_J$			- 55 to 125	$^\circ\text{C}$	
Maximum storage temperature range	$T_{Stg}$			- 55 to 150		
Maximum thermal resistance, junction to case per leg	$R_{thJC}$	DC operation See fig. 4		1.5	$^\circ\text{C}/\text{W}$	
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, smooth and greased		0.50		
Maximum thermal resistance, junction to ambient	$R_{thJA}$	DC operation		40		
Approximate weight				2	g	
				0.07	oz.	
Mounting torque	minimum	Non-lubricated threads		6 (5)	$\text{k}\text{gf} \cdot \text{cm}$ (lbf · in)	
	maximum			12 (10)		
Marking device		Case style D <sup>2</sup> PAK		40L15CTS		
		Case style TO-262		40L15CT-1		

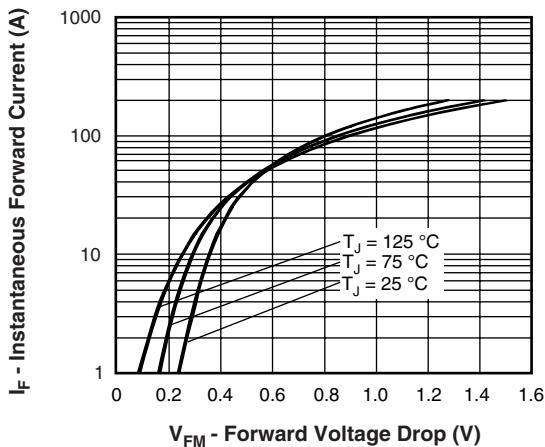


Fig. 1 - Maximum Forward Voltage Drop Characteristics

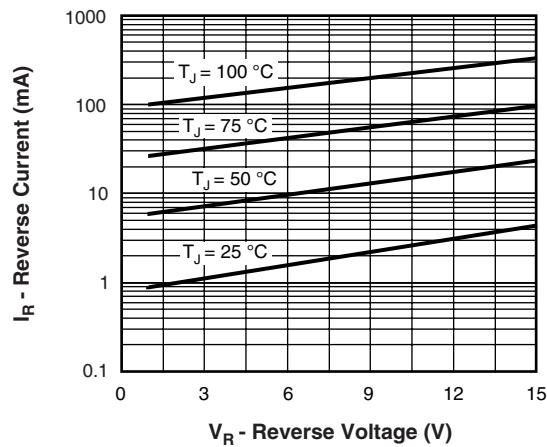


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

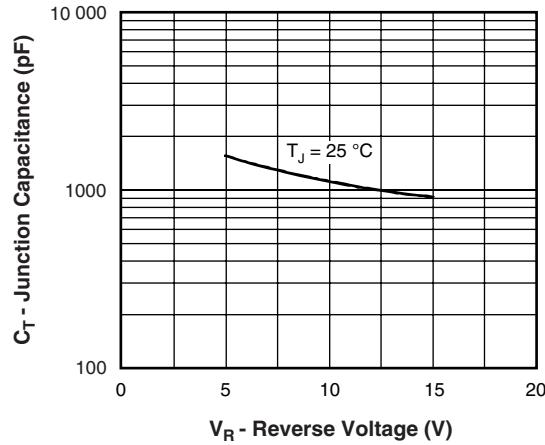


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

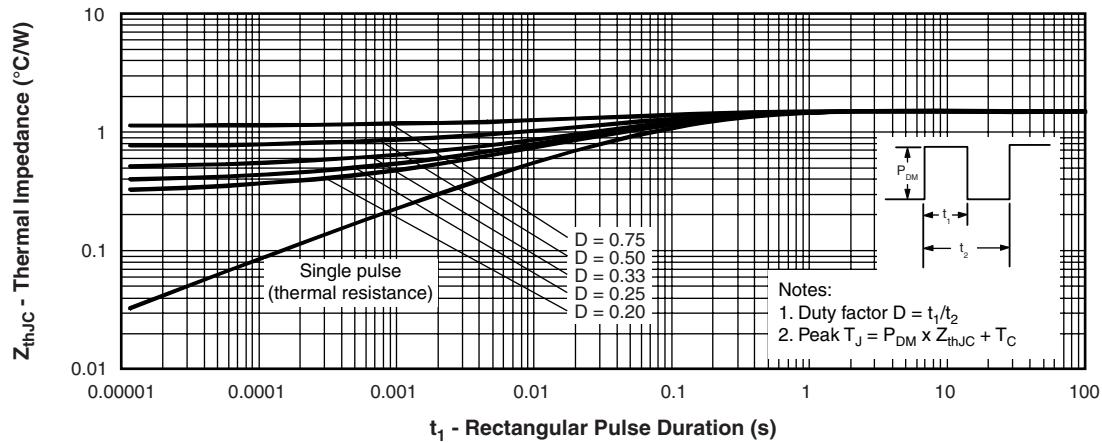


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

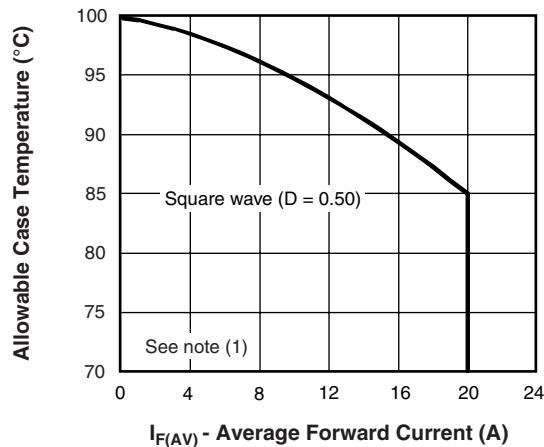


Fig. 5 - Maximum Allowable Case Temperature vs.  
Average Forward Current

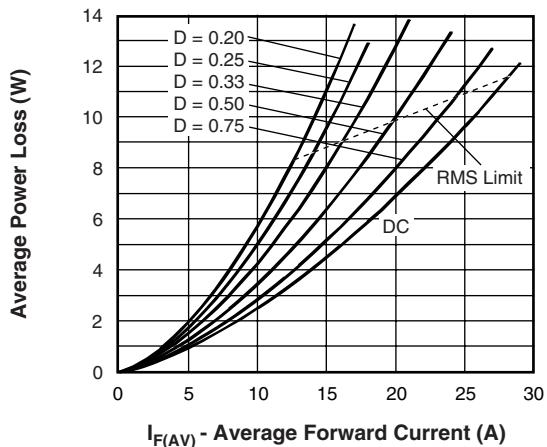


Fig. 6 - Forward Power Loss Characteristics

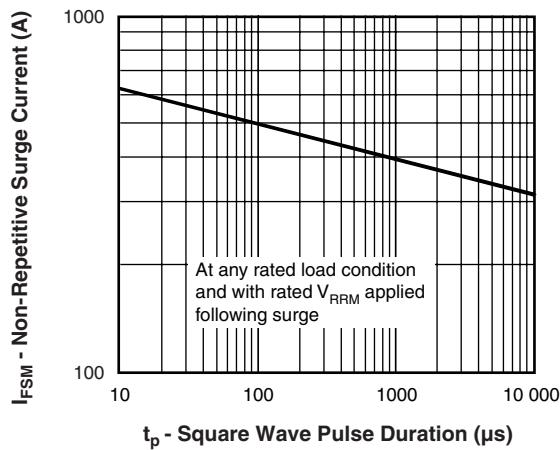


Fig. 7 - Maximum Non-Repetitive Surge Current

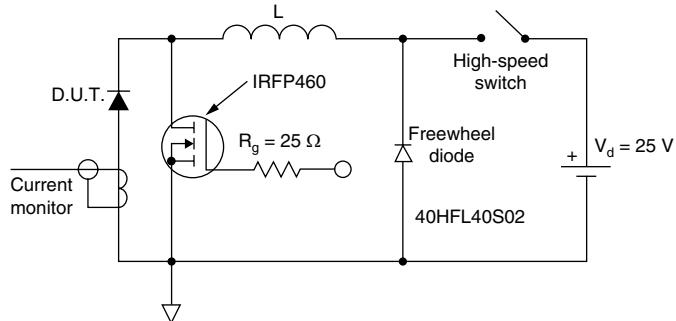


Fig. 8 - Unclamped Inductive Test Circuit

### Note

<sup>(1)</sup> Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d = \text{Forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6);}$   
 $P_{dREV} = \text{Inverse power loss} = V_{R1} \times I_R (1 - D); I_R \text{ at } V_{R1} = 80\% \text{ rated } V_R$

### ORDERING INFORMATION TABLE

Device code	VS-	40	L	15	C	T	S	TRL	PbF
	(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)

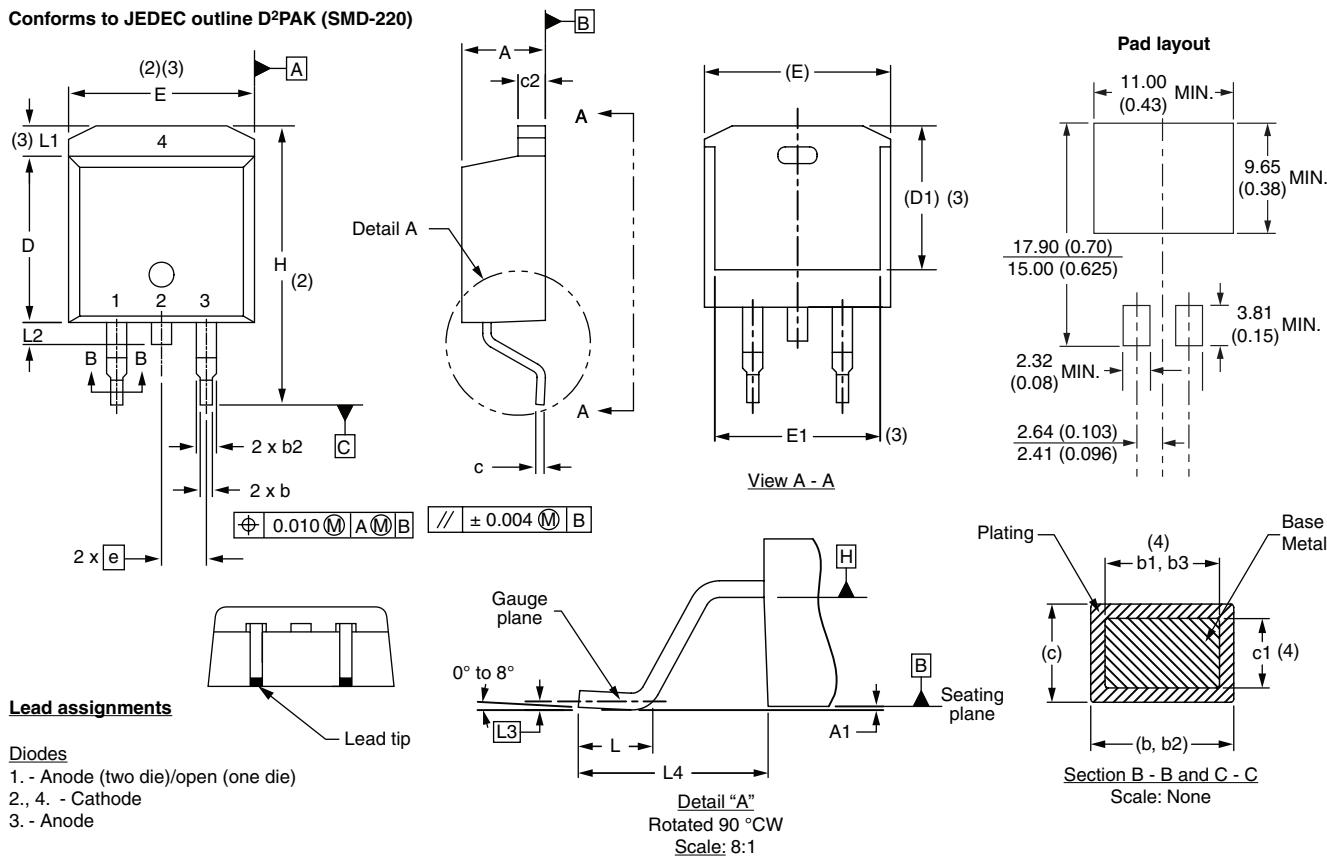
- 1** - HPP product suffix
- 2** - Current rating (40 A)
- 3** - L = Schottky "L" series
- 4** - Voltage rating (15 V)
- 5** - C = Common cathode
- 6** - T = TO-220
- 7** - • S = D<sup>2</sup>PAK  
• -1 = TO-262
- 8** - • None = Tube (50 pieces)  
• TRL = Tape and reel (left oriented - for D<sup>2</sup>PAK only)  
• TRR = Tape and reel (right oriented - for D<sup>2</sup>PAK only)
- 9** - PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95014">www.vishay.com/doc?95014</a>
Part marking information	<a href="http://www.vishay.com/doc?95008">www.vishay.com/doc?95008</a>
Packaging information	<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>

### D<sup>2</sup>PAK, TO-262

#### DIMENSIONS FOR D<sup>2</sup>PAK in millimeters and inches

Conforms to JEDEC outline D<sup>2</sup>PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES		SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.				MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		e	2.54 BSC		0.100 BSC		
b2	1.14	1.78	0.045	0.070			H	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
c	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25 BSC		0.010 BSC		
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

(7) Outline conforms to JEDEC outline TO-263AB

# Outline Dimensions

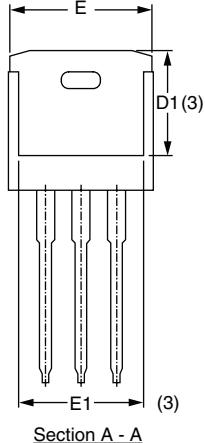
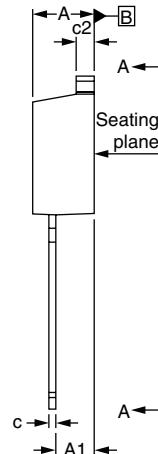
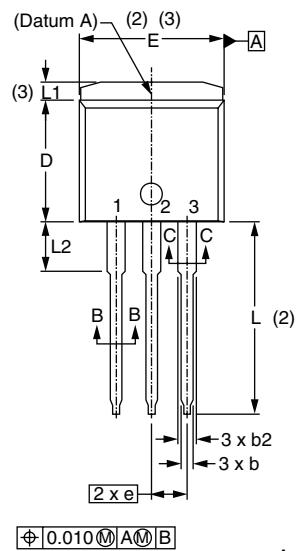
Vishay High Power Products

D<sup>2</sup>PAK, TO-262

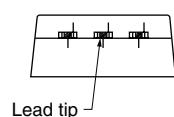


## DIMENSIONS FOR TO-262 in millimeters and inches

Modified JEDEC outline TO-262



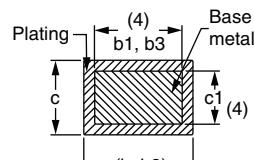
Section A - A



Lead assignments

Diodes

1. - Anode (two die)/open (one die)
- 2., 4. - Cathode
3. - Anode



Section B - B and C - C

Scale: None

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline

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